

#### DESCRIPTION

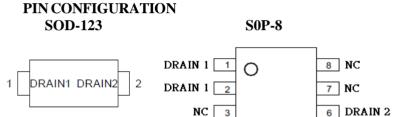
SP687 blocks current flow in the X2 capacitor safety discharge resistors, reducing the power loss to less than 5mW at 230 VAC. When AC voltage is disconnected, SP687 automatically discharges the X2 capacitor by connecting the series discharge resistors. This operation allows total flexibility in the choice of the X2 capacitor to optimize differential mode EMI filtering and reduce inductor costs, with no change in power consumption. SP687 meets IEC 62368-1: 2020 version.

### APPLICATIONS

- ◆ AC/DC Switching Power Adaptor/Desktop
- Battery Charger
- ◆ Open-Frame Switching Power Supply
- ◆ LED Power Supply

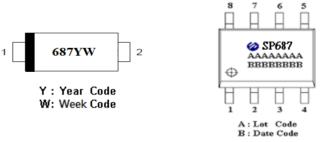
#### **FEATURES**

- 750V CDMOS Process
- Auto Re-Start
- X2 Capacitor Discharge
- Less than 5mW power consumption at 230VAC
- SOP-8/SOD-123 Package design



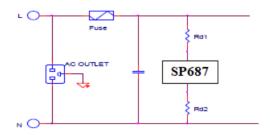
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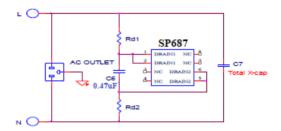
## PART MARKING



5 DRAIN 2

### TYPICALAPPLCATION CIRCUIT



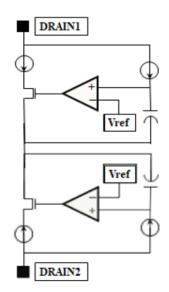


## **ORDERINGINFORMATION**

Part Number	Package	Part Marking
SP687D12RGB	SOD123	687YW
SP687S8RGB	SOP-8	SP687

SP689D12RGB: Tape Reel; Pb – Free; Halogen-Free
 SP689S25RGB: Tape Reel; Pb – Free; Halogen-Free

# **BLOCK DIAGRAM**





**ABSOULTE MAXIMUM RATINGS** (T<sub>A</sub>=25°C, unless otherwise specified.)

The following ratings designate persistent limits beyond which damage to the device may occur.

PARAMETER	•	Symbol	RATINGS	Unit	
Turn on ID Max. Current Continues		$I_D$	7.5	mA	
Package Power Dissipation @ TA ≤ 25°C (SOP8)		$P_{D}$	0.85	W	
Package Power Dissipation @ TA ≤ 25°C (SOD123)		$P_D$	0.5	W	
Drain1 to Drain2 Voltage		$V_{ m DSS}$	750	V	
Operating Ambient Temperature	SOP-8	T <sub>OA</sub>	85	°C	
Storage Temperature	SOP-8	$T_{ m STG}$	-65~+150	°C	
Junction to Ambient *	SOP-8	$\theta_{ m JA}$	147	°C/W	
Case Temperature	501-6	$\theta_{ m JC}$	28		
Operating Ambient Temperature	SOD123	$T_{OA}$	85	°C	
Storage Temperature	SOD123	$T_{ m STG}$	-55~+150	°C	
Junction to Ambient *	SOD122	$ heta_{ m JA}$	250		
Case Temperature	SOD123	$\theta_{ m JC}$	50	°C/W	

<sup>(\*)</sup> The power dissipation and thermal resistance are evaluated under copper board mounted with free air conditions.



# **ELECTRICAL CHARACTERISTICS**

 $(T_A=25^{\circ}C, V_{HV}=30V, unless otherwise specified.)$ 

PARAMETER	SYMBOL	TEST CONDITIONS	Min	Тур	Max	Unit	
Breakdown Voltage							
Drain1(d1) to Drain2 (d2)	$\mathrm{BV}_{\mathrm{DSS}}$		700			V	
Internal MOSFET Turn On Delay Time	e						
700V MOSFET On delay time	Ton delay	Vd1d2=50V, Rd1+Rd2=10.2K		200	400	mS	
700V MOSFET On delay time	Ton delay	Vd1d2=127V, Rd1+Rd2=10.2K		70	140	mS	
700V MOSFET Discharge Current							
700V MOSFET Discharge Current	$I_D$	Vd1d2=50V, Rd1+Rd2=10.2K		3.8		mA	
Discharge Time Test (400V discharged t	to 60V)						
400V to 60V discharging time test	Tdischarging	Rd1&Rd2=10.2K; Cx=0.47uF		45		mS	
Supply Current Without Turning on Internal MOSFET							
Supply Current @ line Frequency=47Hz	I supply ac	Vin=230 Vac and Frequency=47Hz			20	uA	



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